

< C band internally matched power GaAs FET >

MGFC45V6472A

6.4 - 7.2 GHz BAND / 32W

DESCRIPTION

The MGFC45V6472A is an internally impedance-matched GaAs power FET especially designed for use in 6.4 - 7.2 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Class A operation

Internally matched to 50(ohm) systemHigh output power

- P1dB=32W (TYP.) @f=6.4 7.2GHz • High power gain
- GLP=8.0dB (TYP.) @f=6.4 7.2GHz • High power added efficiency
- P.A.E.=28% (TYP.) @f=6.4 7.2GHz • Low distortion [item -51]
- IM3=-45dBc (TYP.) @Po=34.5dBm S.C.L

APPLICATION

- item 01 : 6.4 7.2 GHz band power amplifier
- item 51 : 6.4 7.2 GHz band digital radio communication

• IG

RECOMMENDED BIAS CONDITIONS

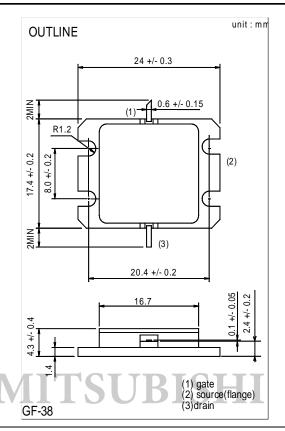
• VDS=10V • ID=8.0A • RG=25ohm

Absolute maximum ratings (Ta=25°C)

| Symbol | Parameter | Ratings | Unit |
|--------|----------------------------------|-------------|------|
| VGDO | Gate to drain breakdown voltage | je -15 | |
| VGSO | Gate to source breakdown voltage | -15 | V |
| ID | Drain current | 25 | А |
| IGR | Reverse gate current | -80 | mA |
| IGF | Forward gate current | 168 | mA |
| PT *1 | Total power dissipation | 150 | W |
| Tch | Cannel temperature | 175 | °C |
| Tstg | Storage temperature | -65 to +175 | °C |

*1 : Tc=25°C

Electrical characteristics (Ta=25°C)



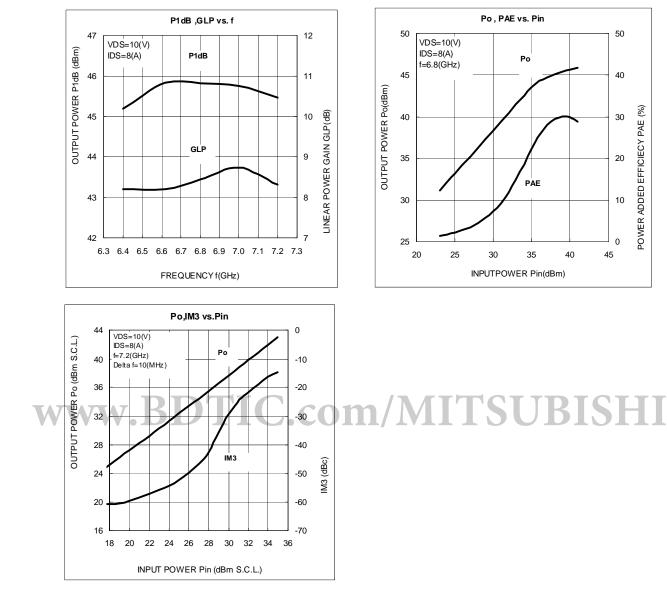
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| Symbol | Parameter | Test conditions | Limits | | | Unit |
|--------------|--------------------------------------|-------------------------|--------|------|------|------|
| | | | Min. | Тур. | Max. | |
| IDSS | Saturated drain current | VDS=3V,VGS=0V | - | 24 | - | А |
| gm | Transconductance | VDS=3V,ID=6.4A | - | 8 | - | S |
| VGS(off) | Gate to source cut-off voltage | VDS=3V,ID=120mA | - | - | -5 | V |
| P1dB | Output power at 1dB gain compression | VDS=10V,ID(RF off)=8.0A | 44.5 | 45 | - | dBm |
| GLP | Linear Power Gain | f=6.4 – 7.2GHz | 7 | 8 | - | dB |
| P.A.E. | Power added efficiency | | - | 28 | - | % |
| IM3 *2 | 3rd order IM distortion | | -42 | -45 | - | dBc |
| Rth(ch-c) *3 | Thermal resistance |] | - | - | 1 | °C/W |

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*2 :item -51 ,2 tone test,Po=34.5dBm Single Carrier Level ,f=7.2GHz,delta f=10MHz

*3 :Channel-case



MGFC45V6472A TYPICAL CHARACTERISTICS(Ta=25deg.C)

MGFC45V6472A S-parameters(Ta=25deg.C , VDS=10(V),IDS=8.0(A))

| | S Parameters (TYP.) | | | | | | | |
|-------|---------------------|-------------|-------|-------------|-------|-------------|-------|-------------|
| f | S11 | | S21 | | S12 | | S22 | |
| (GHz) | Magn. | Angle(deg.) | Magn. | Angle(deg.) | Magn. | Angle(deg.) | Magn. | Angle(deg.) |
| 6.4 | 0.66 | 100 | 2.39 | -106 | 0.057 | -171 | 0.32 | 74 |
| 6.5 | 0.61 | 84 | 2.43 | -122 | 0.065 | 174 | 0.34 | 64 |
| 6.6 | 0.56 | 70 | 2.47 | -138 | 0.071 | 160 | 0.35 | 52 |
| 6.7 | 0.50 | 57 | 2.54 | -154 | 0.079 | 145 | 0.35 | 40 |
| 6.8 | 0.43 | 42 | 2.59 | -170 | 0.088 | 131 | 0.34 | 27 |
| 6.9 | 0.35 | 27 | 2.66 | 173 | 0.095 | 116 | 0.31 | 12 |
| 7.0 | 0.24 | 12 | 2.73 | 155 | 0.101 | 100 | 0.27 | -8 |
| 7.1 | 0.15 | 1 | 2.75 | 143 | 0.105 | 88 | 0.24 | -27 |
| 7.2 | 0.01 | -10 | 2.72 | 123 | 0.109 | 70 | 0.20 | -61 |

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